

DIM400DDS12-A000

Dual Switch IGBT Module

Replaces DS5841-2

DS5841-3 July 2014 (LN31762)

FEATURES

- 10µs Short Circuit Withstand
- Non Punch Through Silicon
- Isolated Cu Base with Al₂O₃ Substrates
- Lead Free Construction

APPLICATIONS

- High Reliability Inverters
- Motor Controllers

The Powerline range of high power modules includes half bridge, chopper, dual, single and bi-directional switch configurations covering voltages from 600V to 3300V and currents up to 2400A.

The DIM400DDS12-A000 is a dual switch 1200V, n-channel enhancement mode, insulated gate bipolar transistor (IGBT) module. The IGBT has a wide reverse bias safe operating area (RBSOA) plus 10µs short circuit withstand. This device is optimised for traction drives and other applications requiring high thermal cycling capability.

The module incorporates an electrically isolated base plate and low inductance construction enabling circuit designers to optimise circuit layouts and utilise grounded heat sinks for safety.

ORDERING INFORMATION

Order As:

DIM400DDS12-A000

Note: When ordering, please use the complete part number

KEY PARAMETERS

V_{CES}		1200V
V _{CE(sat)}	* (typ)	2.2 V
l _c `´	(max)	400A
I _{C(PK)}	(max)	800A

^{*} Measured at the power busbars, not the auxiliary terminals

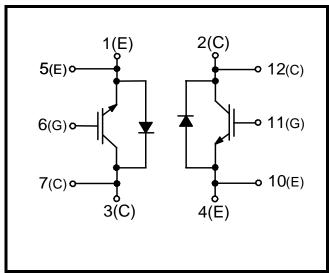


Fig. 1 Circuit configuration

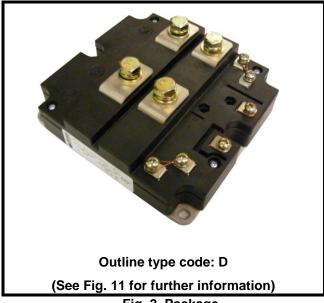


Fig. 2 Package



ABSOLUTE MAXIMUM RATINGS

Stresses above those listed under 'Absolute Maximum Ratings' may cause permanent damage to the device. In extreme conditions, as with all semiconductors, this may include potentially hazardous rupture of the package. Appropriate safety precautions should always be followed. Exposure to Absolute Maximum Ratings may affect device reliability.

T_{case} = 25°C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units
V _{CES}	Collector-emitter voltage	V _{GE} = 0V	1200	V
V _{GES}	Gate-emitter voltage		±20	V
I _C	Continuous collector current	T _{case} = 85°C	400	Α
I _{C(PK)}	Peak collector current	1ms, T _{case} = 115°C	800	Α
P _{max}	Max. transistor power dissipation	$T_{case} = 25^{\circ}C, T_{j} = 150^{\circ}C$	3470	W
l ² t	Diode I ² t value	$V_R = 0, t_p = 10 \text{ms}, T_j = 125^{\circ}\text{C}$	25	kA ² s
V _{isol}	Isolation voltage – per module	Commoned terminals to base plate. AC RMS, 1 min, 50Hz	2500	V

THERMAL AND MECHANICAL RATINGS

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Units
R _{th(j-c)}	Thermal resistance – transistor (per switch)	Continuous dissipation - junction to case	-	-	36	°C/kW
R _{th(j-c)}	Thermal resistance – diode (per switch)	Continuous dissipation - junction to case	-	-	80	°C/kW
$R_{\text{th(c-h)}}$	Thermal resistance – case to heatsink (per module)	Mounting torque 5Nm (with mounting grease)	-	-	8	°C/kW
T_j	Junction temperature	Transistor	-	-	150	°C
		Diode	-	-	125	°C
T _{stg}	Storage temperature range	-	-40	-	125	°C
		Mounting – M6	-	-	5	Nm
	Screw torque	Electrical connections – M4	-	-	2	Nm
		Electrical connections – M8	-	-	10	Nm



ELECTRICAL CHARACTERISTICS

 T_{case} = 25°C unless stated otherwise.

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
I _{CES}	Collector cut-off current	$V_{GE} = 0V$, $V_{CE} = V_{CES}$			0.5	mA
		$V_{GE} = 0V$, $V_{CE} = V_{CES}$, $T_{case} = 125$ °C			12	mA
I _{GES}	Gate leakage current	$V_{GE} = \pm 20V, V_{CE} = 0V$			2	μA
V _{GE(TH)}	Gate threshold voltage	$I_C = 20$ mA, $V_{GE} = V_{CE}$	4.5	5.5	6.5	V
	Collector-emitter saturation voltage	V _{GE} = 15V, I _C = 400A		2.2	2.8	V
V _{CE(sat)}		V _{GE} = 15V, I _C = 400A, T _j = 125°C		2.6	3.2	V
I _F	Diode forward current	DC			400	Α
I _{FM}	Diode maximum forward current	t _p = 1ms			800	Α
	Diode forward voltage	I _F = 400A		2.1	2.4	V
V_{F}		I _F = 400A, T _j = 125°C		2.1	2.4	V
C _{ies}	Input capacitance	$V_{CE} = 25V, V_{GE} = 0V, f = 1MHz$		45		nF
Qg	Gate charge	±15V		4		μC
C _{res}	Reverse transfer capacitance	$V_{CE} = 25V, V_{GE} = 0V, f = 1MHz$				nF
L _M	Module inductance – per switch			20		nΗ
R _{INT}	Internal transistor resistance – per switch			270		μΩ
SC _{Data}	Short circuit current, I _{SC}	$T_{j} = 125^{\circ}\text{C}, V_{CC} = 900\text{V}$ $t_{p} \le 10\mu\text{s}, V_{GE} \le 15\text{V}$ $V_{CE \text{ (max)}} = V_{CES} - L^{*} x \text{ dI/dt}$ IEC 60747-9		2250		А

Note:

L is the circuit inductance + L_M



ELECTRICAL CHARACTERISTICS

T_{case} = 25°C unless stated otherwise

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Units
$t_{d(off)}$	Turn-off delay time			710		ns
t _f	Fall time	$I_{C} = 400A$ $V_{GE} = \pm 15V$		70		ns
E _{OFF}	Turn-off energy loss	$V_{CE} = 600V$		60		mJ
t _{d(on)}	Turn-on delay time	$R_{G(ON)} = 3.3\Omega$		190		ns
t _r	Rise time	$R_{G(OFF)} = 3.3\Omega$ $L_S \sim 100$ nH		100		ns
E _{ON}	Turn-on energy loss	25 .001111		40		mJ
Q_{rr}	Diode reverse recovery charge	I _F = 400A		55		μC
I _{rr}	Diode reverse recovery current	V _{CE} = 600V		300		Α
E _{rec}	Diode reverse recovery energy	$dI_F/dt = 4700A/\mu s$		17		mJ

T_{case} = 125°C unless stated otherwise

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Units
t _{d(off)}	Turn-off delay time	$I_{C} = 400A$ $V_{GF} = \pm 15V$		890		ns
t _f	Fall time			100		ns
E _{OFF}	Turn-off energy loss	$V_{GE} = £13V$ $V_{CE} = 600V$		60		mJ
t _{d(on)}	Turn-on delay time	$R_{G(ON)} = 3.3\Omega$ $R_{G(OFF)} = 3.3\Omega$ $L_S \sim 100 \text{nH}$		440		ns
t _r	Rise time			125		ns
E _{ON}	Turn-on energy loss			60		mJ
Q_{rr}	Diode reverse recovery charge	$I_F = 400A$ $V_{CE} = 600V$ $dI_F/dt = 4000A/\mu s$		85		μC
I _{rr}	Diode reverse recovery current			320		Α
E _{rec}	Diode reverse recovery energy			32		mJ



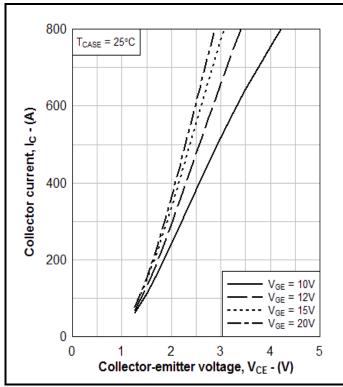


Fig. 3 Typical output characteristics

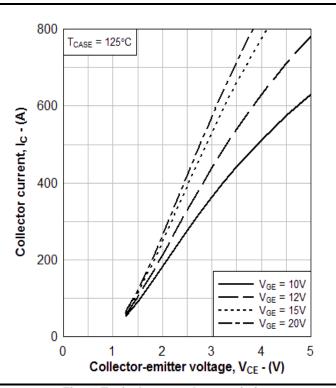


Fig. 4 Typical output characteristics

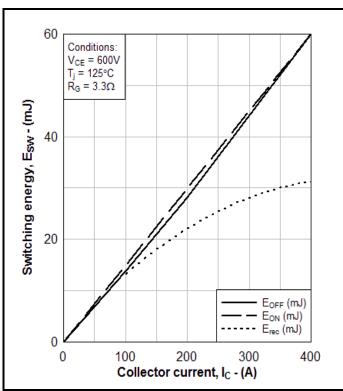


Fig. 5 Typical switching energy vs collector current

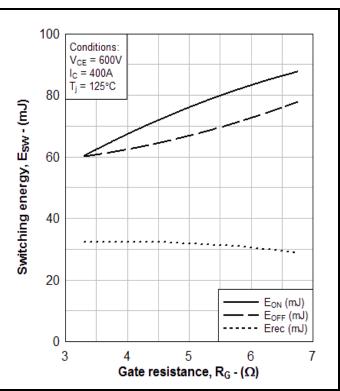


Fig. 6 Typical switching energy vs gate resistance



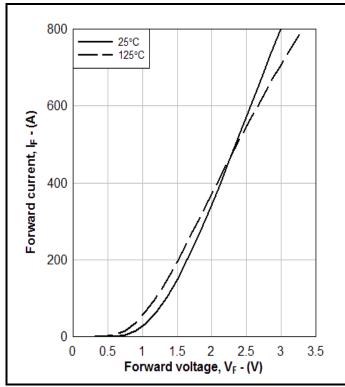


Fig. 7 Diode typical forward characteristics

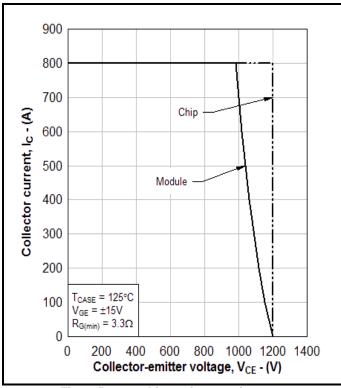


Fig. 8 Reverse bias safe operating area

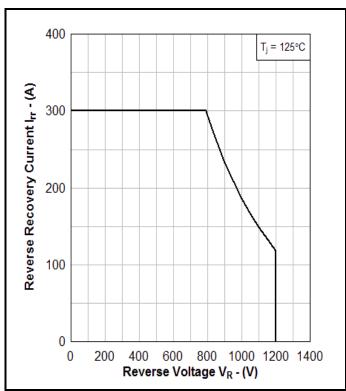


Fig. 9 Diode reverse bias safe operating area

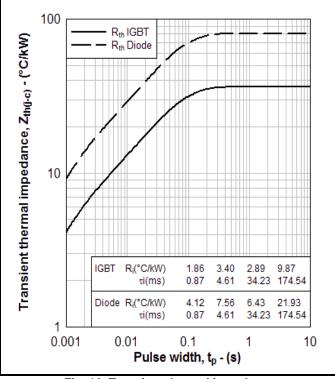


Fig. 10 Transient thermal impedance



PACKAGE DETAILS

For further package information, please visit our website or contact Customer Services. All dimensions in mm, unless stated otherwise.

DO NOT SCALE.

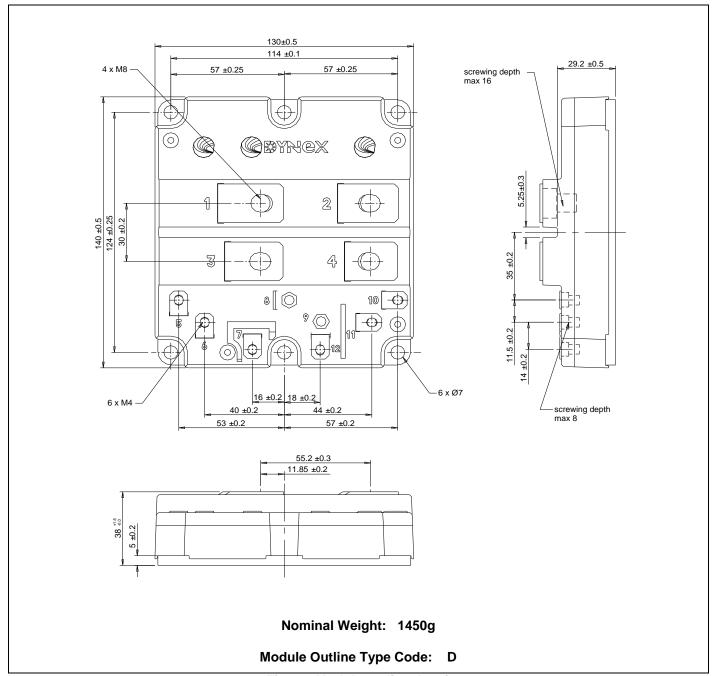


Fig. 11 Module outline drawing



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